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August 2011



FAN5365 1A / 0.8A, 6MHz Digitally Programmable Regulator

Features

- High Efficiency (>88%) at 6MHz
- 800mA or 1A Output Current
- Regulation Maintained with V_{IN} from 2.3V to 5.5V
- 6-Bit V_{OUT} Programmable from 0.75 to 1.975V
- 6MHz Fixed-Frequency Operation (PWM Mode)
- Excellent Load and Line Transient Response
- Small Size, 470nH Inductor Solution
- ±2% DC Voltage Accuracy in PWM Mode
- 25ns Minimum On-Time
- High-Efficiency, Low-Ripple, Light-Load PFM
- Smooth Transition between PWM and PFM
- 40µA Operating PFM Quiescent Current
- I²C[™]-Compatible Interface up to 3.4Mbps
- Pin-Selectable or I²CTM Programmable Output Voltage
- 9-Bump, 1.27 x 1.29mm, 0.4mm Pitch WLCSP Package

Applications

- 3G, WiFi[®], WiMAX[™], and WiBro[®] Data Cards
- Netbooks[®], Ultra-Mobile PCs
- SmartReflex™-Compliant Power Supply
- Split Supply DSPs and µP Solutions OMAP™, XSCALE™
- Handset Graphic Processors (NVIDIA[®], ATI)

Description

The FAN5365 is a high-frequency, ultra-fast transient response, synchronous step-down, DC-DC converter optimized for low-power applications using small, low-cost inductors and capacitors. The FAN5365 supports up to 800mA or 1A load current.

The FAN5365 is ideal for mobile phones and similar portable applications powered by a single-cell Lithium-Ion battery. With an output voltage range adjustable via I^2C^{TM} interface from 0.75V to 1.975V, it supports low-voltage DSPs and processors, core power supplies, and memory modules in smart phones, data cards, and hand-held computers.

The FAN5365 operates at 6MHz (nominal) fixed switching frequency in $\ensuremath{\mathsf{PWM}}$ mode.

During light-load conditions, the regulator includes a PFM mode to enhance light-load efficiency. The regulator transitions smoothly between PWM and PFM modes with no glitches on V_{OUT} . In hardware shutdown, the current consumption is reduced to less than 200nA.

The serial interface is compatible with fast / standard mode, fast mode plus, and high-speed mode I^2C specifications, allowing transfers up to 3.4Mbps. This interface is used for dynamic voltage scaling with 12.5mV voltage steps, for reprogramming the mode of operation (PFM or forced PWM), or to disable/enable the output voltage.

The chip's advanced protection features include short-circuit protection and current and temperature limits. During a sustained over-current event, the IC shuts down and restarts after a delay to reduce average power dissipation into a fault.

During startup, the IC controls the output slew rate to minimize input current and output overshoot at the end of soft-start. The IC maintains a consistent soft-start ramp, regardless of output load during startup.

The FAN5365 is available in a 1.27 x 1.29mm, 9-bump WLCSP package.

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Ordering Information

Part Number ⁽¹⁾	Option	Slave	Addres	s LSB	Output Current	V _{out} Prog	gramming	Powe Defa	er-up aults	Package
	-	A2	A1	A0	mA	Min.	Max.	VSEL0	VSEL1	_
FAN5365UC00X	00	0	1	0	800	0.7500	1.4375 ⁽³⁾	1.05	1.20	WLCSP-09
FAN5365UC02X	02	1	1	0	800	0.7500	1.4375 ⁽³⁾	0.95	1.10	WLCSP-09
FAN5365UC03X ⁽²⁾	03	0	0	0	1000	0.7500	1.5375	1.00	1.20	WLCSP-09
FAN5355UC06X ⁽²⁾	06	0	0	0	1000	1.1875	1.9750	1.80	1.80	WLCSP-09

Notes:

- 1. The "X" designator on the part number indicates tape and reel packaging.
- 2. Preliminary; not full production release at this time. Contact a Fairchild representative for information.
- 3. V_{OUT} is limited to the maximum voltage for all VSEL codes greater than the maximum V_{OUT} listed.

Typical Application

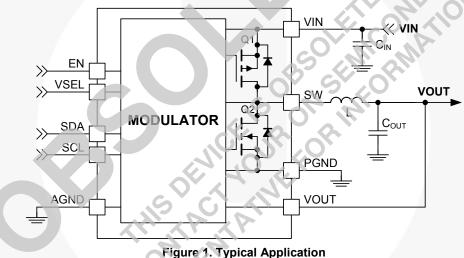


Table 1. Recommended External Components

Component	Description	Vendor	Parameter	Min.	Тур.	Max.	Units
	470nH Nominal	Murata TDK EDK	L ⁽⁴⁾	390	470	600	nH
L (L _{OUT})	470nn Nominal	Murata, TDK, FDK	DCR (Series R)	/	80		mΩ
C _{OUT} ⁽⁵⁾	0603 (1.6x0.8x0.8), 10μF X5R	Various	C ⁽⁶⁾	2.2	10.0	15.0	μF
C _{IN}	0402 (1x0.5x0.25), 4.7μF X5R	Taiyo-Yuden		1.6	4.7		μF

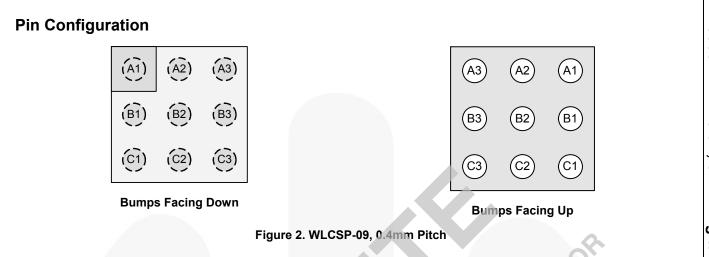
Notes:

4. Minimum L incorporates tolerance, temperature, and partial saturation effects (L decreases when increasing current).

5. A capacitor similar to C_{IN} can be used for C_{OUT} . With 1.4V of bias, a 4.7 μ F 0402 capacitor minimum value is 2.5 μ F.

The regulator is stable, but transient response degraded due to large signal effects.

 Minimum C is a function of initial tolerance, maximum temperature, and the effective capacitance being reduced due to frequency, dielectric, and voltage bias effects. C_{IN} is biased with a higher voltage which reduces its effective capacitance by a larger amount.



Pin Definitions

Pin #	Name	Description
A1	VSEL	Voltage Select . When HIGH, V_{OUT} is set by VSEL1. When LOW, V_{OUT} is set by VSEL0. This behavior can be overridden through I ² C register settings. This pin should not be left floating.
A2	VIN	Input Voltage. Connect to input power source. The connection from this pin to C _{IN} should be as short as possible.
A3	SDA	SDA. I ² C interface serial data. This pin should not be left floating.
B1	SW	Switching Node. Connect to output inductor.
B2	SCL	SCL. I ² C interface serial clock. This pin should not be left floating.
B3	EN	Enable. When this pin is HIGH, the circuit is enabled. When LOW, part enters shutdown mode and input current is minimized. This pin should not be left floating.
C1	VOUT	Output Voltage Monitor. The this pin to the output voltage at COUT. This is a signal input pin to the control circuit and does not carry DC current.
C2	PGND	Power GND . Power return for gate drive and power transistors. Connect to AGND on PCB. The connection from this pin to the bottom of C_{IN} should be as short as possible.
C3	AGND	Analog GND . This is the signal ground reference for the IC. All voltage levels are measured with respect to this pin. AGND should be connected to PGND at a single point.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Pa	rameter	Min.	Max.	Units
	VIN, SW Pins		-0.3	6.5	
V _{CC}	Vout		-0.3	2.5	V
	Other Pins		-0.3	V _{IN} + 0.3 ⁽⁷⁾	
		Human Body Model, JESD22-A114		3	
ESD	Electrostatic Discharge Protection	Charged Device Model, JESD22-C101		1	KV
TJ	Junction Temperature		-40	+150	°C
T _{STG}	Storage Temperature		-65	+150	°C
TL	Lead Soldering Temperature, 10 Sec	conds	, C	+260	°C

Note:

7. Lesser of 6.5V or V_{CC} +0.3V.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
VIN	Supply Voltage	2.3	5.5	V
V _{CCIO}	SDA and SCL Voltage Swing ⁽⁸⁾	1.2	2.0	V
T _A	Ambient Temperature	-40	+85	°C
TJ	Junction Temperature	-40	+125	°C

Note:

8. The I²C interface operates with t_{HD;DAT} = 0 as long as the pull-up voltage for SDA and SCL is less than 2.5V. If voltage swings greater than 2.5V are required (for example, if the I²C bus is pulled up to V_{IN}), the minimum t_{HD;DAT} must be increased to 80ns. Most I²C masters change SDA near the midpoint between the falling and rising edges of SCL, which provides ample t_{HD;DAT}.

Dissipation Ratings⁽⁹⁾

Package	$R_{\theta JA}^{(10)}$	Power Rating at T _A ≤ 25°C	Derating Factor > T _A = 25°C
Wafer-Level Chip-Scale Package (WLCSP)	110°C/W	900mW	9mW/ºC

Notes:

9. Maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = [T_{J(max)} - T_A] / \theta_{JA}$.

10. This thermal data is measured with a high-K board (four-layer board, according to the JESD51-7 JEDEC standard).

Electrical Specifications

Unless otherwise noted, over the recommended operating range for V_{IN} and T_A , EN = VSEL = SCL = SDA = 1.8V, and register VSEL0[6] bit = 1. Typical values are at V_{IN} = 3.6V, T_A = 25°C. Circuit and components according to Figure 1.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Power Su	upplies			1	1	1
		I _O = 0mA, PFM Mode, 2.3V<=V _{IN} <=4.5V		40	55	
lq	Quiescent Current	I ₀ = 0mA, PFM Mode, 2.3V<=V _{IN} <=5.5V	40 58 40 68 40 68 6.3 0.1 0.1 1.0 N/A N/A 2.18 2.2 1.95 2.02 160 0.1 1.05 0.1 0.01 1.0 0.01 1.0 0.01 1.0 0.01 1.0 0.02 1.1 200 0.2 0.3 1.1 1150 1350 160 1300 1550 184 150 20 20 5.4 6.0 6.1 -2.0 2.0 2.0	65	μA	
		I _O = 0mA, 6MHz PWM Mode		6.3		mA
		EN = GND		0.1	1.0	
I _{SD}	Shutdown Supply Current	EN = V _{IN} , EN_DCDC bit = 0, SDA = SCL = 1.8V (Software Shutdown)		N/A	N/A	μA
V	Linder Veltage Leekeut Threshold	V _{IN} Rising		2.18	2.25	V
V _{UVLO}	Under-Voltage Lockout Threshold	V _{IN} Falling	1.95	2.02		V
VUVHYST	Under-Voltage Lockout Hysteresis			160		mV
ENABLE	, VSEL, SDA, SCL			6		
VIH	HIGH-Level Input Voltage		1.05			V
VIL	LOW-Level Input Voltage				0.4	V
I _{IN}	Input Bias Current	Input Tied to GND or V _{IN}	D X	0.01	1.00	μA
Power Sv	witch and Protection		10	•		
R _{DS(ON)P}	P-Channel MOSFET On Resistance	V _{IN} = 3.6V		300		mΩ
I _{LKGP}	P-Channel Leakage Current	V _{DS} = 5.5V		0.2	1.0	μA
R _{DS(ON)N}	N-Channel MOSFET On Resistance	V _{IN} = 3.6V		200		mΩ
I _{LKGN}	N-Channel Leakage Current	V _{DS} = 5.5V		0.3	1.0	μA
		Options 00, 02	1150	1350	1600	
LIMPK	P-MOS Current Limit	Options 03, 06	1300	1550	1840	mA
T _{LIMIT}	Thermal Shutdown			150		°C
T _{HYST}	Thermal Shutdown Hysteresis	SCA		20		°C
Frequence	cy Control					
f _{SW}	Switching Frequency ⁽¹¹⁾	PWM Operation	5.4	6.0	6.6	MHz
Output R	Regulation					
	G	$I_{OUT(DC)} = 0$, Forced PWM, $V_{OUT} = VSEL1$ Default Value	-1.5		1.5	%
Vout	Vout Accuracy	$2.3V \le V_{IN} \le 5.5V$, V_{OUT} from Minimum to Maximum, $I_{OUT(DC)} = 0$ to 1A, Forced PWM	-2.0		2.0	%
	PILE PL	$2.3V \le V_{IN} \le 5.5V$, V_{OUT} from Minimum to Maximum, $I_{OUT(DC)} = 0$ to 1A, Auto PWM/PFM	-2.0		3.5	%
$\frac{\Delta V_{OUT}}{\Delta I_{LOAD}}$	Load Regulation	I _{OUT(DC)} = 0 to 1A, Forced PWM		-0.2	K	%/A
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	$2.3V \le V_{IN} \le 5.5V$, $I_{OUT(DC)} = 300mA$, Forced PWM		0		%/V
V _{RIPPLE}	Output Ripple Voltage	PWM Mode, V _{OUT} = 1.2V		4		mV _{P-F}
		PFM Mode, I _{OUT(DC)} = 10mA		1.0		mV _{P-F}

FAN5365 — 1A / 0.8A, 6MHz Digitally Programmable Regulator

Electrical Specifications (Continued)

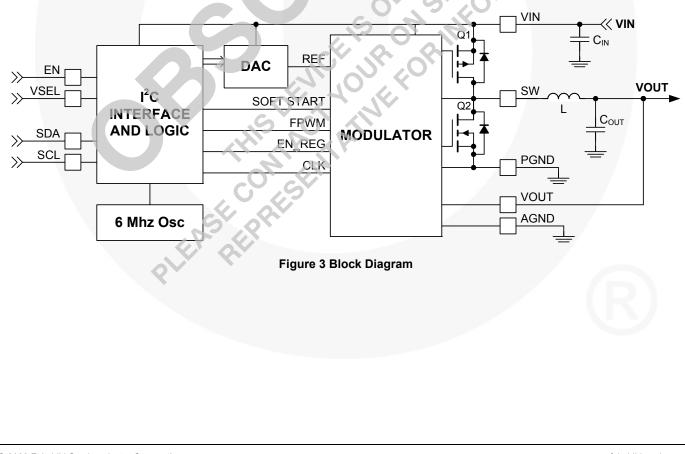
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Parameter	Conditions	Min.	Тур.	Max.	Units
·					
Resolution			6		Bits
Differential Nonlinearity	Monotonicity Assured by Design			0.8	LSB
EN HIGH to I ² C Start		250			μS
Vout LOW to HIGH Settling	Transition from 0.75V to 1.438V V _{OUT} Settled to within 2% of Setpoint		7	-	μS
			0		
Regulator Enable to Regulated V _{OUT}	$R_{LOAD} \ge 5\Omega$, to V_{OUT} = Power-up Default	J.C	140	180	μS
	Resolution Differential Nonlinearity EN HIGH to I ² C Start V _{OUT} LOW to HIGH Settling	Resolution Image: Second Sec	Resolution Monotonicity Assured by Design Differential Nonlinearity Monotonicity Assured by Design EN HIGH to I ² C Start 250 V _{OUT} LOW to HIGH Settling Transition from 0.75V to 1.438V V _{OUT} Settled to within 2% of Setpoint	Resolution 6 Differential Nonlinearity Monotonicity Assured by Design EN HIGH to I ² C Start 250 V _{OUT} LOW to HIGH Settling Transition from 0.75V to 1.438V V _{OUT} Settled to within 2% of Setpoint 7	Resolution 6 Differential Nonlinearity Monotonicity Assured by Design 0.8 EN HIGH to I ² C Start 250 V _{OUT} LOW to HIGH Settling Transition from 0.75V to 1.438V V _{OUT} Settled to within 2% of Setpoint 7

Notes:

11. Limited by the effect of t_{OFF} minimum (see Figure 14 in Typical Performance Characteristics)

Block Diagram



I²C Timing Specifications

Guaranteed by design.

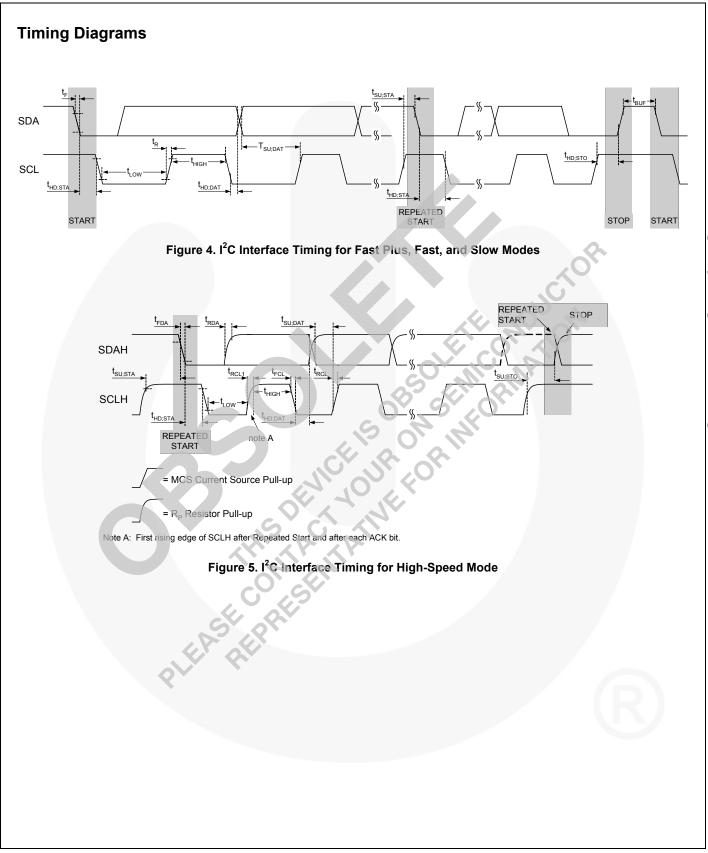
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
		Standard Mode			100		
		Fast Mode			400		
f _{SCL}	SCL Clock Frequency	Fast Mode Plus			1000	kHz	
		High-Speed Mode, $C_B \leq 100 pF$			3400		
	tBuF Bus-free Time between STOP and START Conditions ID:STA START or Repeated START Hold Time ID:STA SCL LOW Period HIGH SCL HIGH Period BU:STA Repeated START Setup Time	High-Speed Mode, $C_B \leq 400 pF$			1700		
		Standard Mode		4.7			
Tour		Fast Mode		1.3		μS	
	START Conditions	Fast Mode Plus		0.5			
		Standard Mode		4		μS	
	START or Repeated START Hold	Fast Mode		600		ns	
		Fast Mode Plus		260	2	ns	
		High-Speed Mode		160		ns	
		Standard Mode		4.7		μS	
	Fast Mode		1.3		μS		
t _{LOW}	SCL LOW Period	Fast Mode Plus		0.5		μS	
		High-Speed Mode, C _B < 100pF		160.0		ns	
		High-Speed Mode, C _B < 400pF		320.0		ns	
		Standard Mode		4		μS	
		Fast Mode), –	600		ns	
t _{HIGH}	SCL HIGH Period	Fast Mode Plus		260		ns	
-11011		High-Speed Mode, C _B < 100pF		60		ns	
		High-Speed Mode, $C_B \le 400 pF$		120		ns	
		Standard Mode		4.7		μS	
		Fast Mode		600.0		ns	
t _{su;sta}	Repeated START Setup Time	Fast Mode Plus	_	260.0		ns	
		High-Speed Mode		160.0		ns	
		Standard Mode		250		-	
		Fast Mode		100			
t _{SU;DAT}	Data Setup Time	Fast Mode Plus	7	50		ns	
		High-Speed Mode		10			
		Standard Mode	0		3.45	μS	
	28	Fast Mode	0		900.00	ns	
t _{HD;DAT}	Data Hold Time ⁽⁸⁾	Fast Mode Plus	0		450.00	ns	
		High-Speed Mode, C _B <u><</u> 100pF	0		70.00	ns	
	×	High-Speed Mode, $C_B \leq 400 pF$	0		150.00	ns	
		Standard Mode	20+0.	1C _B	1000		
		Fast Mode		20+0.1C _B 300			
t _{RCL}	SCL Rise Time	Fast Mode Plus	20+0.	_	120	ns	
		High-Speed Mode, C _B < 100pF		10	80	-	
		High-Speed Mode, $C_B \leq 400 pF$		20	160		

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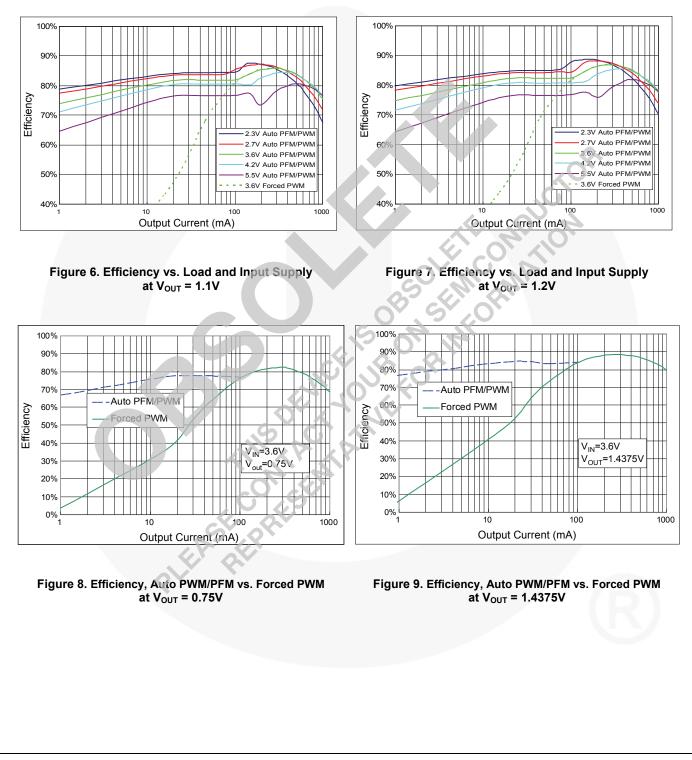
I²C Timing Specifications (Continued)

Guaranteed by design.

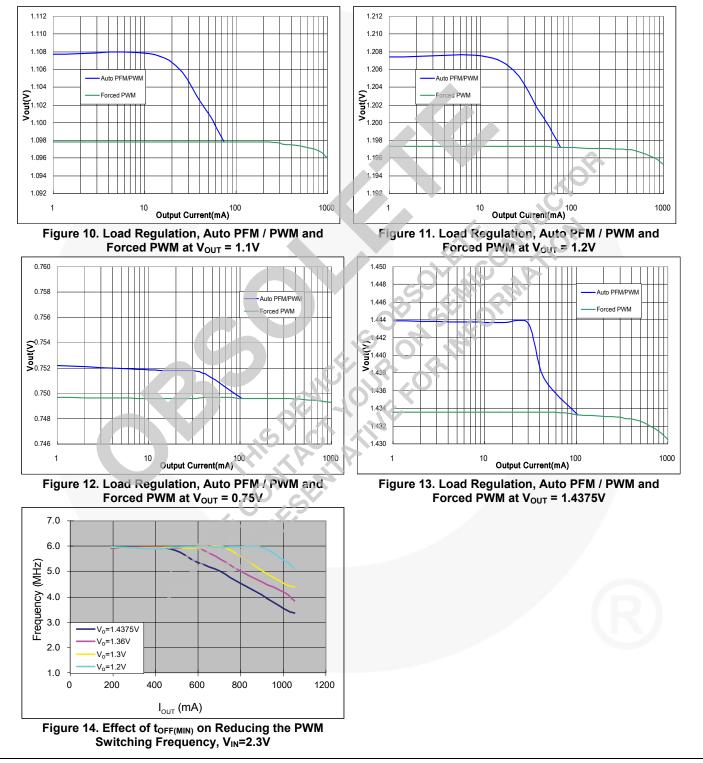
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
		Standard Mode	20+0.	1C _B	300	
		Fast Mode		20+0.1C _B		
t _{FCL}	SCL Fall Time	Fast Mode Plus		20+0.1C _B		ns
		High-Speed Mode, C _B < 100pF		10	40	
		High-Speed Mode, C _B < 400pF		20	80	
	Rise Time of SCL after a Repeated	High-Speed Mode, C _B < 100pF		10	80	
t _{RCL1}	START Condition and after ACK Bit	High-Speed Mode, $C_B \leq 400 pF$		20	160	ns
		Standard Mode	20+0.	1C _B	1000	
		Fast Mode	20+0.	1C _B	300	
t _{RDA}	SDA Rise Time	Fast Mode Plus	20+0.	1C _B	120	ns
		High-Speed Mode, $C_B \leq 100 pF$		10	80	
		High-Speed Mode, $C_B \leq 400 pF$		20	160	
		Standard Mode	20+0.	1C _B	300	
t _{FDA} SDA Fall Time		Fast Mode	20+0.	1C _B	300	ns
	SDA Fall Time	Fast Mode Plus	20+0.	1C _B	120	
		High-Speed Mode, C _B < 100pF		10	80	
		High-Speed Mode, C _B < 400pF		20	160	
		Standard Mode		4		μS
	Sten Candilian Satur Time	Fast Mode	0	600		ns
t _{su;sto}	Stop Condition Setup Time	Fast Mode Plus		120		ns
		High-Speed Mode		160		ns
C _B	Capacitive Load for SDA and SCL				400	pF
	Stop Condition Setup Time Capacitive Load for SDA and SCL	DENT OUT FC				
	PILE. PL					



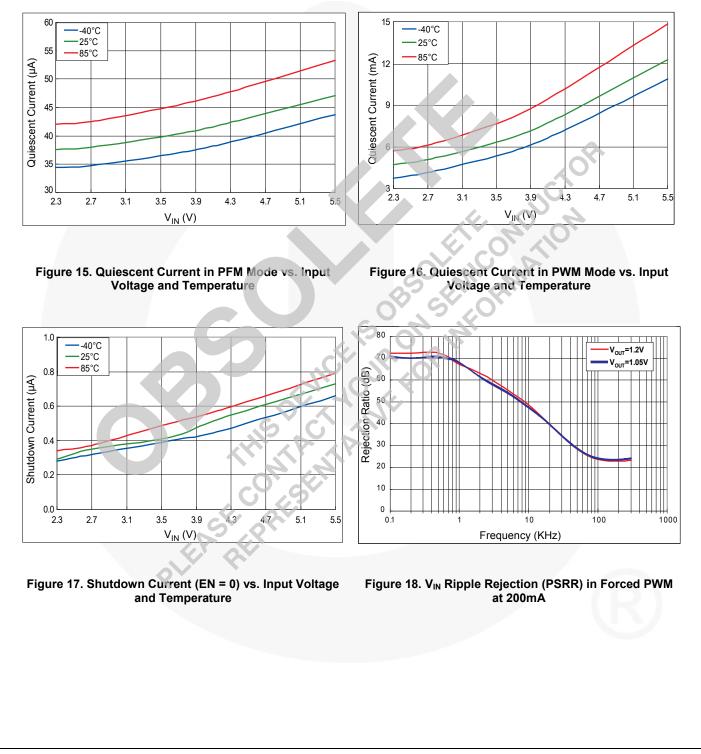
Unless otherwise specified, Auto PWM/PFM, V_{IN} = 3.6V, SCL = SCA = VSEL = EN = 1.8V, T_A = 25°C; circuit and components according to Figure 1.



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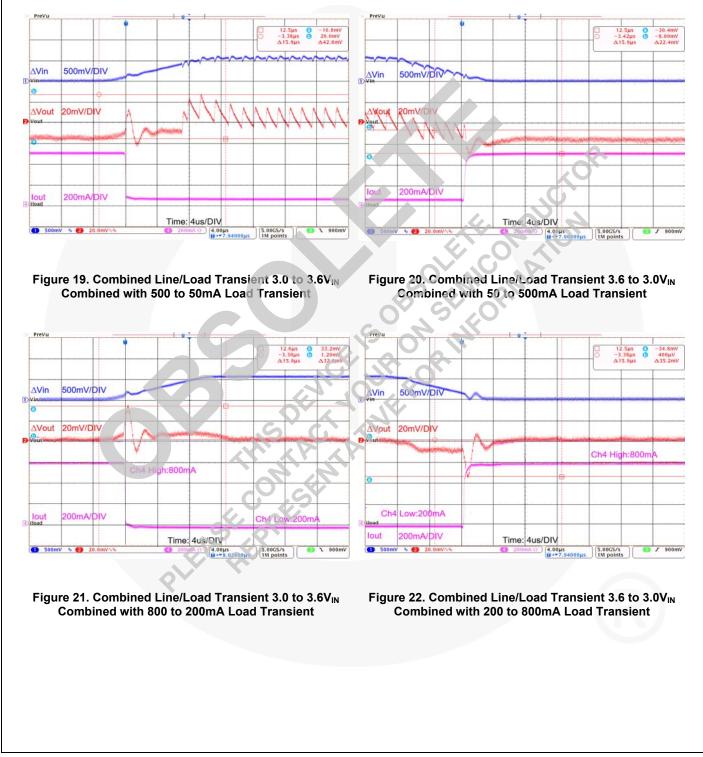
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FAN5365 — 1A / 0.8A, 6MHz Digitally Programmable Regulator

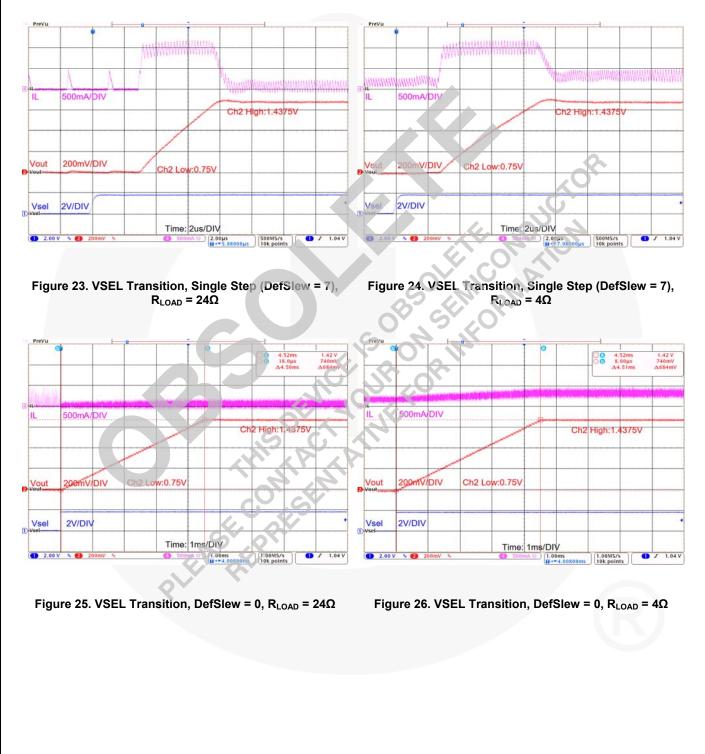
Typical Characteristics

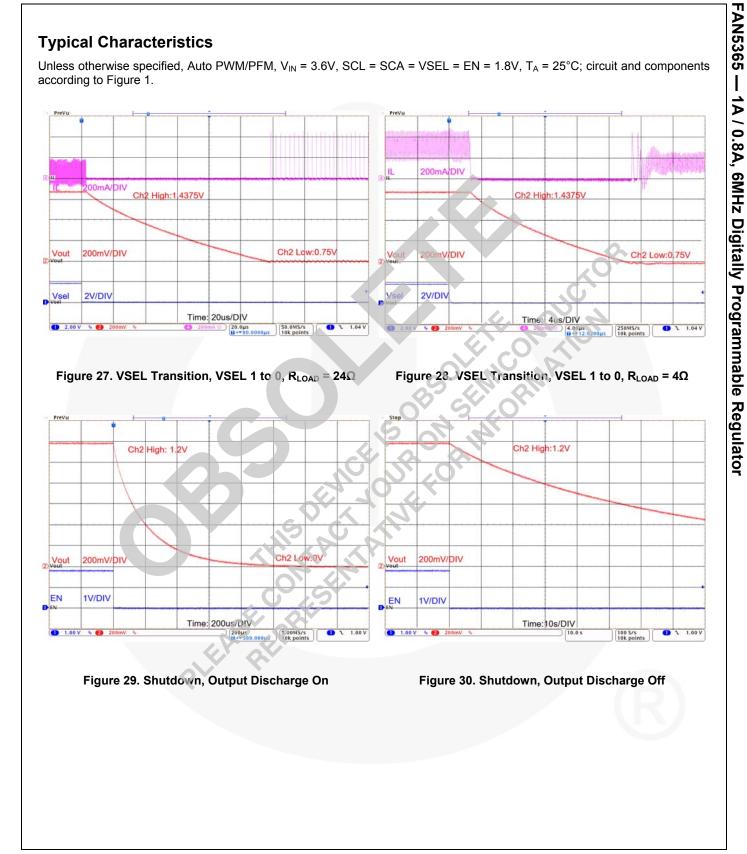
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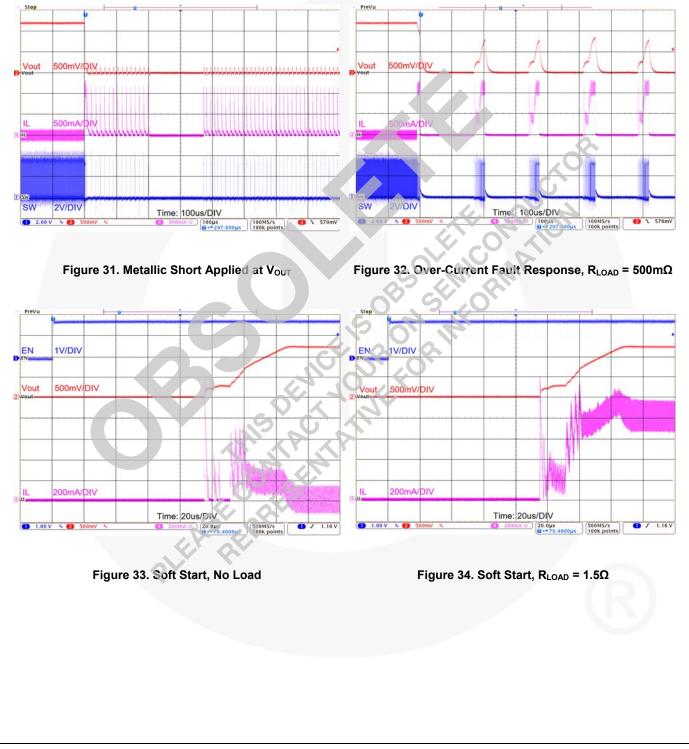
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Circuit Description

The FAN5365 is a synchronous buck regulator that typically operates at 6MHz with moderate to heavy load currents. At light load currents, the converter operates in power-saving PFM mode. The regulator automatically transitions between fixed-frequency PWM mode and variable-frequency PFM mode to maintain the highest possible efficiency over the full range of load current.

The FAN5365 uses a very fast, non-linear control architecture to achieve excellent transient response with minimum-sized external components.

The FAN5365 integrates an I^2 C-compatible interface, allowing transfers up to 3.4Mbps. This communication interface can be used to:

- Dynamically re-program the output voltage in 12.5mV increments
- Reprogram the mode of operation to enable or disable PFM mode
- Control voltage transition slew rate
- Enable / disable the regulator.

For more details, refer to the l^2C Interface and Register Description sections.

Output Voltage Programming

V_{OUT} is programmed according to the following equations:

Option ⁽¹²⁾	V _{OUT} Equation	
00, 02, 03	$V_{OUT} = 0.75 + N_{VSEL} \bullet 12.5 mV$	(1)
06	$V_{OUT} = 1.1875 + N_{VSEL} \bullet 12.5mV$	(2)

Note:

12. For option 00 and 02, the maximum voltage is 1.4375 V.

VSEL	Value		VOUT			
Dec (NVSEL)	Binary	Hex	00, 02	03	06	
0	000000	00	0.7500	0.7500	1.1875	
1	000001	01	0.7625	0.7625	1.2000	
2	000010	02	0.7750	0.7750	1.2125	
3	000011	03	0.7875	0.7875	1.2250	
4	000100	04	0.8000	0.8000	1.2375	
5	000101	05	0.8125	0.8125	1.2500	
6	000110	06	0.8250	0.8250	1.2625	
7	000111	07	0.8375	0.8375	1.2750	
8	001000	08	0.8500	0.8500	1.2875	
9	001001	09	0.8625	0.8625	1.3000	
10	001010	00	0.8750	0.8750	1.3125	
11	001010	0B	0.8875	0.8875	1.3250	
. 12	001100	00	0.9000	0.9000	1.3375	
13	001101	00 0D	0.9000	0.9125	1.3500	
14	001110	0D 0E	0.9250	0.9250	1.3625	
15	001111	0E 0F	0.9250	0.9230	-	
					1.3750	
16	010000	10	0.9500	0.9500	1.3875	
17	010001	11	0.9625	0.9625	1.4000	
18	010010	12	0.9750	0.9750	1.4125	
19	010011	13	0.9875	0.9875	1.4250	
20	010100	14	1.0000	1.0000	1.4375	
21	010101	15	1.0125	1.0125	1.4500	
22	010110	16	1.0250	1.0250	1.4625	
23	010111	17	1.0375	1.0375	1.4750	
24	011000	18	1.0500	1.0500	1.4875	
25	011001	19	1.0625	1.0625	1.5000	
26	011010	1A	1.0750	1.0750	1.5125	
27	011011	1B	1.0875	1.0875	1.5250	
28	011100	1C	1.1000	1.1000	1.5375	
29	011101	1D	1.1125	1.1125	1.5500	
30	011110	1E	1.1250	1.1250	1.5625	
31	011111	1F	1.1375	1.1375	1.5750	
32	100000	20	1.1500	1.1500	1.5875	
33	100001	21	1.1625	1.1625	1.6000	
34	100010	22	1.1750	1.1750	1.6125	
35	100011	23	1.1875	1.1875	1.6250	
36	100100	24	1.2000	1.2000	1.6375	
37	100101	25	1.2125	1.2125	1.6500	
38	100110	26	1.2250	1.2250	1.6625	
39	100111	27	1.2375	1.2375	1.6750	
40	101000	28	1.2500	1.2500	1.6875	
41	101001	29	1.2625	1.2625	1.7000	
42	101010	2A	1.2750	1.2750	1.7125	
43	101011	2B	1.2875	1.2875	1.7250	
44	101011	2D	1.3000	1.3000	1.7375	
45	101100	20 2D	1.3125	1.3125	1.7500	
45	101110	2D 2E	1.3250	1.3250	1.7625	
40	101111	2E 2F	1.3250	1.3375	1.7625	
47	110000	2F 30	1.3500	1.3500	1.7750	
49	110001	31	1.3625	1.3625	1.8000	
50	110010	32	1.3750	1.3750	1.8125	
51	110011	33	1.3875	1.3875	1.8250	
52	110100	34	1.4000	1.4000	1.8375	
53	110101	35	1.4125	1.4125	1.8500	
54	110110	36	1.4250	1.4250	1.8625	
55	110111	37	1.4375	1.4375	1.8750	
56	111000	38	1.4375	1.4500	1.8875	
57	111001	39	1.4375	1.4625	1.9000	
58	111010	3A	1.4375	1.4750	1.9125	
59	111011	3B	1.4375	1.4875	1.9250	
60	111100	3C	1.4375	1.5000	1.9375	
61	111101	3D	1.4375	1.5125	1.9500	
62	111110	3E	1.4375	1.5250	1.9625	
63	111111	3F	1.4375	1.5375	1.9750	

Power-Up, EN, and Soft-Start

All internal circuits remain de-biased and the IC is in a very low quiescent current state until the following are true:

- V_{IN} is above its rising UVLO threshold, and
- EN is HIGH.

At that point, the IC begins a soft-start cycle, its I^2C interface is enabled, and its registers are loaded with their default values.

During the initial soft-start, V_{OUT} ramps linearly to the setpoint programmed in the VSEL register selected by the VSEL pin. The soft-start features a fixed output voltage slew rate of 20V/ms and achieves regulation approximately 90µs after EN rises. PFM mode is enabled during soft-start until the output is in regulation, regardless of the MODE bit settings. This allows the regulator to start into a partially charged output without discharging it; in other words, the regulator does not allow current to flow from the load back to the battery.

As soon as the output has reached its setpoint, the control forces PWM mode for about $85\mu s$ to allow all internal control circuits to calibrate.

Table 3. Soft-Start Timing

Symbol	Description	Value (µs)
tssdly	Time from EN to start of soft- start ramp	100
t _{REG}	Vout ramp start to regulation	(VSEL-0.1) X 53
t _{РОК}	PWROK (CONTROL2[5]) rising from t _{REG}	11
t _{CAL}	Regulator stays in PWM mode during this time	G 10
EN		

PWROK

Figure 35. Soft-Start Timing

Table 4. EN_DCDC Behavior

EN_DCDC Bit	EN Pin	I ² C	REGULATOR		
0	0	OFF	OFF		
1	1	ON	ON		
1	0	OFF	OFF		
0	1	ON	OFF		

Software Enable

The EN_DCDC bit, VSELx[7], can be used to enable the regulator in conjunction with the EN pin. Setting EN_DCDC with EN HIGH begins the soft-start sequence described above.

Light-Load (PFM) Operation

The FAN5365 provides a low ripple, single-pulse, PFM mode that ensures:

- Smooth transitions between PFM and PWM modes
- Single-pulse operation for low ripple
- Predictable PFM entry and exit currents.

PFM begins after the inductor current has become discontinuous, crossing zero during the PWM cycle for 32 consecutive cycles. PFM exit occurs when discontinuous current mode (DCM) operation cannot supply sufficient current to maintain regulation. During PFM mode, the inductor current ripple is about 40% higher than in PWM mode. The load current required to exit PFM mode is thereby about 20% higher than the load current required to enter PFM mode, providing sufficient hysteresis to prevent "mode chatter."

While PWM ripple voltage is typically less than 4mV_{P-P}, PFM ripple voltage can be up to $30mV_{P-P}$ during very light load. To prevent significant undershoot when a load transient occurs, the initial DC setpoint for the regulator in PFM mode is set 10mV higher than in PWM mode. This offset decays to about 5mV after the regulator has been in PFM mode for ~100 µs. The maximum instantaneous voltage in PFM is 30mV above the setpoint

PFM mode can be disabled by writing to the mode control bits: CONTROL1[3:0] (see Table 5)

Output Voltage Transitions

The IC regulates V_{OUT} to one of two setpoint voltages, as determined by the VSEL pin and the HW_nSW bit.

Table 5.	V _{OUT} Setpoint and Mode Control
	MODE_CTRL, CONTROL1[3:2] = 00

VSEL Pin	HW_nSW Bit	V _{OUT} Setpoint	PFM
0	1	VSEL0	Allowed
1	1	VSEL1	Per MODE1
х	0	VSEL1	Per MODE1

If HW_nSW = 0, V_{OUT} transitions are initiated through the following sequence:

- 1. Write the new setpoint in VSEL1.
- Write desired transition rate in DEFSLEW, CONTROL2[2:0], and set the GO bit in CONTROL2[7].

If HW_nSW = 1, V_{OUT} transitions are initiated either by changing the state of the VSEL pin or by writing to the VSEL register selected by the VSEL pin.

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Positive Transitions

When transitioning to a higher V_{OUT} , the regulator can perform the transition using multi-step or single-step mode.

Multi-Step Mode:

The internal DAC is stepped at a rate defined by DEFSLEW, CONTROL2[2:0], ranging from 000 to 110. This mode minimizes the current required to charge C_{OUT} and thereby minimizes the current drain from the battery when transitioning. The PWROK bit, CONTROL2[5], remains LOW until about 1.5µs after the DAC completes its ramp.

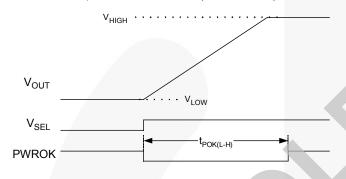


Figure 36. Multi-Step VOUT Transition

Single-Step Mode:

Used if DEFSLEW, CONTROL2[2:0] = 111. The internal DAC is immediately set to the higher voltage and the regulator performs the transition as quickly as its current limit circuit allows, while avoiding excessive overshoot.

Figure 37 shows single-step transition timing. $t_{V(L-H)}$ is the time it takes the regulator to settle to within 2% of the new setpoint, typically 7µs for a full-range transition. The PWROK bit, CONTROL2[5], goes LOW until the transition is complete and V_{OUT} settled. This typically occurs ~2µs after t_{V(L-H)}.

It is good practice to reduce the load current before making positive V_{SEL} transitions. This reduces the time required to make positive load transitions and avoids current-limit-induced overshoot.

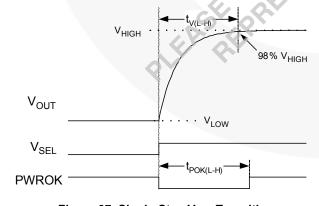


Figure 37. Single-Step VOUT Transition

All positive V_{OUT} transitions inhibit PFM until the transition is complete, which occurs at the end of $t_{POK(L-H)}$.

Negative Transitions

When moving from $V_{SEL} = 1$ to $V_{SEL} = 0$, the regulator enters PFM mode, regardless of the condition of the MODE bits, and remains in PFM until the transition is complete. Reverse current through the inductor is blocked, and the PFM minimum frequency control inhibited, until the new setpoint is reached; at which time, the regulator resumes control using the mode established by MODE_CTRL. The transition time from V_{HIGH} to V_{LOW} is controlled by load current and output capacitance as:

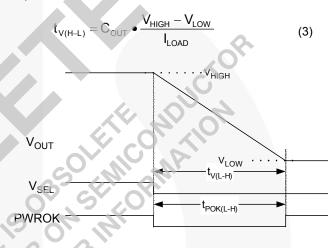


Figure 38. Negative VOUT Transition

Protection Features

Current Limit / Auto-Restart

The regulator includes cycle-by-cycle current limiting, which prevents the instantaneous inductor current from exceeding the "PMOS Current Limit" threshold.

The IC enters "fault" mode after sustained over-current. If current limit is asserted for more than 32 consecutive cycles (about $20\mu s$), the IC returns to shutdown state and remains in that condition for ~80 μs . After that time, the regulator attempts to restart with a normal soft-start cycle. If the fault has not cleared, it shuts down ~20 μs later.

If the fault is a short circuit, the initial current limit is \sim 30% of the normal current limit, which produces a very small drain on the system power source.

Thermal Protection

When the junction temperature of the IC exceeds 150°C, the device turns off all output MOSFETs and remains in a low quiescent current state until the die cools to 130°C before starting a normal soft-start cycle.

Under-Voltage Lockout (UVLO)

The IC turns off all MOSFETs and remains in a low quiescent current state until $V_{\rm IN}$ rises above the UVLO threshold.

I²C Interface

The FAN5365's serial interface is compatible with standard, fast, fast plus, and high-speed mode I²C bus specifications. The FAN5365's SCL line is an input and its SDA line is a bidirectional open-drain output; it can only pull down the bus when active. The SDA line only pulls LOW during data reads and when signaling ACK. All data is shifted in MSB (bit 7) first.

Slave Address

In Table 6, A1 and A0 are according to the Ordering Information table on page 2.

Table 6. I²C Slave Address

7	6	5	4	3	2	1	0
1	0	0	1	A2	A1	A0	R/W

In Hex notation, the slave address assumes a 0 LSB. For example, the hex slave address of option 00 is 94H.

Register Addressing

FAN5365 has four user-accessible registers:

Table 7. I²C Register Address

		Address											
	7	6	5	4	3	2	1	0					
VSEL0	0	0	0	0	0	0	0	0					
VSEL1	0	0	0	0	0	0	0	1					
CONTROL1	0	0	0	0	0	0	1	0					
CONTROL2	0	0	0	0	0	0	1	1					

Bus Timing

As shown in Figure 39, data is normally transferred when SCL is LOW. Data is clocked in on the rising edge of SCL. Typically, data transitions shortly at or after the falling edge of SCL to allow ample time for the data to set up before the next SCL rising edge.

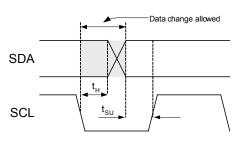


Figure 39. Data Transfer Timing

Each bus transaction begins and ends with SDA and SCL HIGH. A transaction begins with a "START" condition, which is defined as SDA transitioning from 1 to 0 with SCL HIGH, as shown in Figure 40.



Figure 40. Start Bit

A transaction ends with a "STOP" condition, which is defined as SDA transitioning from 0 to 1 with SCL HIGH, shown in Figure 41.

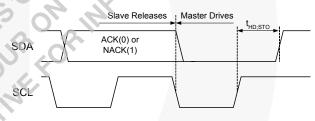


Figure 41. Stop Bit

During a read from the FAN5365 (Figure 44), the master issues a "Repeated Start" command after sending the register address and before resending the slave address. The "Repeated Start" is a 1-to-0 transition on SDA while SCL is HIGH, as shown in Figure 42.

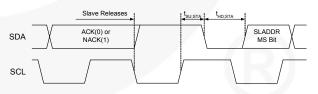


Figure 42. Repeated Start Timing

High-Speed (HS) Mode

The protocols for High-Speed (HS), Low-Speed (LS), and Fast-Speed (FS) modes are identical, except the bus speed for HS mode is 3.4MHz. HS mode is entered when the bus master sends the HS master code 00001XXX after a start condition. The master code is sent in Fast or Fast Plus mode (less than 1MHz clock) and slaves do not acknowledge (ACK) this transmission.

The master then generates a repeated start condition (Figure 42) that causes all slaves on the bus to switch to HS mode. The master then sends I^2C packets, as described above, using the HS mode clock rate and timing.

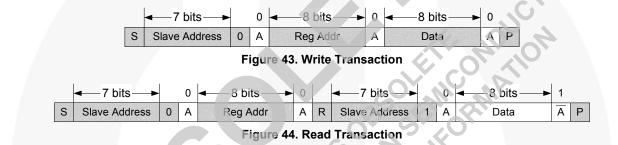
The bus remains in HS mode until a stop bit (Figure 41) is sent by the master. While in HS mode, packets are separated by repeated start conditions.

Read and Write Transactions

The following figures outline the sequences for data read and write. Bus control is signified by the shading of the packet, defined as Master Drives Bus and Slave Drives Bus. All addresses and data are MSB first.

Table 8. I²C Bit Definitions for Figure 43 and Figure 44

Symbol	Definition
S	START, <i>Figure 40.</i>
А	ACK. The slave drives SDA to 0 to acknowledge the preceding packet.
Ā	NACK. The slave sends a 1 to NACK the preceding packet.
R	Repeated START, see Figure 42.
Р	STOP, see Figure 41.



Register Descriptions

Default Values

Each option of the FAN5365 (see Table 9) has different default values for the some of the register bits. Table 9 defines

both the default values and the bit's type (as defined in Table 10) for each available option.

Table 9. Default Values and Bit Types for VsEL and CONTROL Registers

				/SEL	.0		<u>ان ا</u>	<u> </u>								VSE	L1					
Option	7	6	5	4	3	2	-	0	V	ίουτ		Option	7	6	5	4	З	2	1	0	V	DUT
00	1	1	0	1	1	0	0	0	51	.05		00	1	1	1	0	0	1	0	0	1.	20
02	1	1	0	1	0	0	0	0	0	.95		02	1	1	0	1	1	1	0	0	1.	10
03	1	1	0	1	0	1	0	0	1	.00		03	1	1	1	0	0	1	0	0	1.	20
06	1	1	1	1	0	0	0	1	1	.80		06	1	1	1	1	0	0	0	1	1.	80
	CONTROL1 CONTROL2																					
Option		7	6	5	4		3	2	1	0		Optior	۱	7	6	ļ	5	4	3	2	1	0
00, 02		1	0	0	1	(0	0	0	0		00, 02		0	1	()	0	0	1	1	1
03, 06		1	0	0	1	(0	0	0	0		03, 06		0	0	()	0	0	1	1	1
																						1

Table 10. Bit Type Definitions for Table 9

#	Active Bit	Changing this bit changes the behavior of the converter, as described below.
#	Disabled	Converter logic ignores changes made to this bit. Bit can be written and read-back.
#	Read-Only	Writing to this bit through I ² C does not change the read-back value, nor does it change converter behavior.

Bit Definitions

Table 11 defines the operation of each register bit. Superscript characters define the default state for each option. Superscripts 0,2,3,6 signify the default values for

options 00, 02, 03, and 06, respectively. $^{\rm A}$ signifies the default for all options.

Table	11.	Bit	Definitions
1 4 5 1 5			

Bit	Name	Value	Description
VSE	L0		Register Address: 00
7	EN_DCDC	0	Device in shutdown regardless of the state of the EN pin. This bit is mirrored in VSEL1. A write to bit 7 in either register establishes the EN_DCDC value.
		1 ^A	Device enabled when EN pin is HIGH, disabled when EN is LOW.
6	Reserved	1 ^A	
5:0	DAC[5:0]	Table 9 ^A	6-bit DAC value to set V _{OUT} .
VSE	L1		Register Address: 01
7	EN_DCDC	0	Device in shutdown regardless of the state of the EN pin. This bit is mirrored in VSEL1. A write to bit 7 in either register establishes the EN_DCDC value.
		1 ^A	Device enabled when EN pin is HIGH, disabled when EN is LOW.
6	Reserved	1 ^A	
5:0	DAC[5:0]	Table 9 ^A	6-bit DAC value to set V _{OUT} .
CO	NTROL1		Register Address: 02
7:6	Reserved	10 ^A	Vendor ID bits. Writing to these bits has no effect on regulator operation. These bits can be used to distinguish between vendors via I^2C .
5	Reserved	1 ^A	
4	HW_nSW	0	V _{OUT} is controlled by VSEL1. Voltage transitions occur by writing to the VSEL1, then setting the GO bit.
4	1100_11300	1 ^A	V_{OUT} is programmed by the VSEL pin. V_{OUT} = VSEL1 when VSEL is HIGH and V_{OUT} = VSEL0 when VSEL is LOW.
		00 ^A	Operation follows MODE0, MODE1.
2.2		01	PFM with automatic transitions to PWM, regardless of VSEL.
3:Z	MODE_CTRL	10	PFM disabled (forced PWM), regardless of VSEL.
		11	PFM with automatic transitions to PWM, regardless of VSEL.
4		0 ^A	PFM disabled (forced PWM) when regulator output is controlled by VSEL1.
1	MODE1		PFM with automatic transitions to PWM when regulator output is controlled by VSEL1.
0	MODE0	0 ^A	PFM with automatic transitions to PWM when VSEL is LOW. Changing this bit has no effect on the operation of the regulator.
CON	NTROL2		Register Address. 03
-7	22	0 ^A	This bit has no effect when HW_nSW = 1. At the end of a V_{OUT} transition, this bit is reset to 0.
7	GO	1	Starts a V _{OUT} transition if HW nSW = 0.
0	OUTPUT	0 3,6	When the regulator is disabled, V _{OUT} is not discharged.
6	DISCHARGE	1 ^{0,2}	When the regulator is disabled, V _{OUT} discharges through an internal pull-down.
5	PWROK	0	V _{OUT} is not in regulation or is in current limit.
Э	(read only)	10	V _{OUT} is in regulation.
4:3	Reserved	00 ^A	
		000	V_{OUT} slews at 0.15mV/µs during positive V_{OUT} transitions.
		001	V_{OUT} slews at 0.30mV/µs during positive V_{OUT} transitions.
		010	V_{OUT} slews at 0.60mV/µs during positive V_{OUT} transitions.
~ ~		011	V_{OUT} slews at 1.20mV/µs during positive V_{OUT} transitions.
2:0	DEFSLEW	100	V_{OUT} slews at 2.40mV/ μ s during positive V_{OUT} transitions.
		101	V_{OUT} slews at 4.80mV/µs during positive V_{OUT} transitions.
		110	V_{OUT} slews at 9.60mV/µs during positive V_{OUT} transitions.
		111 ^A	Positive V_{OUT} transitions use single-step mode (see Figure 37).
1			

Layout Recommendations

FAN5365 switches at a relatively high frequency of 6MHz; thus the recommended layout should be followed carefully as additional parasitic effects caused by moving components further away or routing through internal layers can cause issues. In addition, possible detrimental effects to regulator performance EMI issues can be generated by introducing unintentional coupling paths in the layout.

To minimize VIN and SW spikes and thereby reduce voltage stress on the IC power switches; it is critical to minimize the loop length for the VIN bypass capacitor. CIN must be placed

next to the IC with routing on the top layer, as shown in Figure 45 and Figure 46.

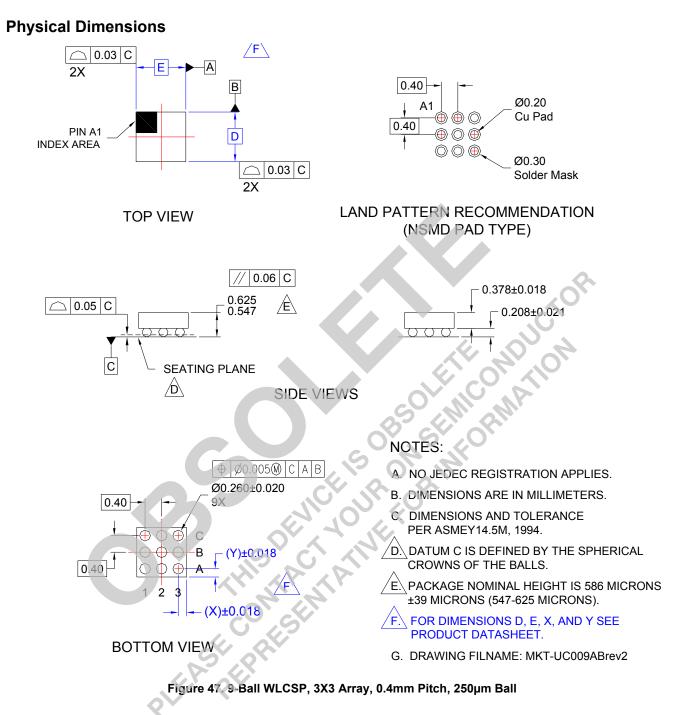
Switching current paths through CIN and COUT should be returned directly to the GND bumps of the IC on the top layer of the printed circuit board (PCB).

The SW node should be treated as a noisy signal and separated by the ground plane or "keepout region" from any sensitive signals in the system. Routing sensitive highimpedance voltage reference signals should be avoided on the layer directly beneath the SW node.



Figure 45. Simplified Layout Drawing

Figure 46. Fairchild Reference Board Layout



Product-Specific Dimensions

Product	D	E	X	Y
FAN5365UC	1.290 +/-0.030	1.270 +/-0.030	0.250	0.250

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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FAN5365

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1A / 0.8A, 6MHz Digitally Programmable Regulator

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Rev. 156

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